Part Order #: IPJ-P6001-Q2AT

Impinj.

Impinj® Monza® X-2K Dura Datasheet

Rev 1.51 March 24th, 2014

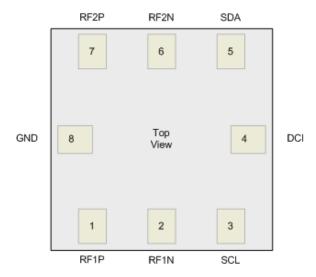


Monza® X-2K Dura is a UHF Gen2 RFID IC product with 2176 bits of Non Volatile Memory (NVM) and an I2C interface.

As an I2C device Monza® X-2K Dura operates as a standard I2C EEPROM. The contents of this EEPROM can also be accessed wirelessly via the UHF Gen2 RFID Protocol.

Features

- EPCglobal and ISO 18000-63 compliant, Gen2V2 compliant.
- 2176 bits of user NVM
- 4 One Time Programmable (OTP) blocks (1664/2160 bits) via blockpermalock feature supported by both I2C and EPC Gen2 interface
- QT for read control and data privacy on RF link
- I2C slave interface with NVM read and write
- -17dBm typical read sensitivity when using a single RF antenna port, -24dBm with DC input
- -19.5dBm typical read sensitivity when using dual RF antenna ports
- -12dBm typical write sensitivity when using a single RF antenna port
- I2C control of RF access
- Write wakeup mode



Name	Description	Characteristic			
RF1_P	Differential RF Input	1.6kΩ, 1pF			
RF1_N	Port 1	-17 dBm single- port sensitivity;			
RF2_P	Differential RF Input	-19.5 dBm True3D			
RF2_N	Port 2	sensitivity			
DCI	DC Input	1.6-3.6V			
SCL	I2C Clock Input	VIH/L=70% / 30%			
SDA	I2C Data Input	DCI IOL=6mA @ 0.4V			
GND					



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1 Introduction

1.1 Scope

This datasheet defines the physical and logical specifications for Gen 2-compliant Monza X-2K Dura tag chip, a reader-talks-first, radio frequency identification (RFID) component operating in the UHF frequency range.

1.2 Reference Documents

EPC™ Radio Frequency Identity Protocols Class-1 Generation-2 UHF RFID Protocol for Communications at 860 MHz – 960 MHz, Version 1.2.0 (Gen 2 Specification). The conventions used in the Gen 2 Specification (normative references, terms and definitions, symbols, abbreviated terms, and notation) were adopted in the drafting of this Monza X-2K Dura Tag Chip Datasheet. Users of this datasheet should familiarize themselves with the Gen 2 Specification.

EPCTM Tag Data Standards Specification

EPCglobal "Interoperability Test System for EPC Compliant Class-1 Generation-2 UHF RFID Devices" v.1.2.4, August 4, 2006. (Monza X-2K Dura tag chips are compliant with this Gen 2 interoperability standard.)

I2C Specification Rev. 03, June 19 2007, NXP Doc UM10204



2 Functional Description

Monza® X-2K Dura chips enable users to communicate wirelessly with the processor inside electronic devices using standard Gen 2 RFID readers, unlocking many new benefits for consumer electronics manufacturers, retailers and end users. Monza X-2K Dura connects to the processor of an electronic device through a standard I2C bus. This enables the processor to read and write the Monza X chip memory with information that is accessible to UHF Gen 2 RFID readers even when the electronic device is powered off. By enabling electronic devices to communicate with RFID readers, Monza X chips deliver a wide range of extended capabilities such as theft deterrence in the supply chain and device configuration/upgrades at point of sale and beyond.

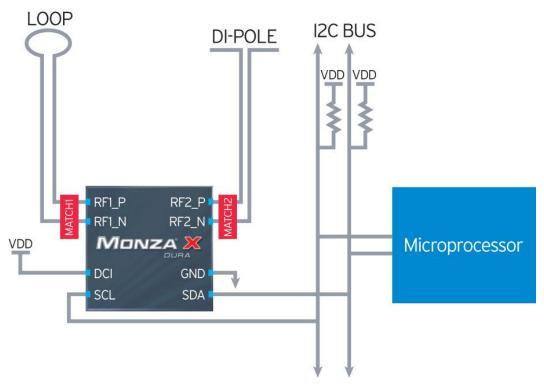


Figure 1 – Monza X-2K Dura connects with microprocessor through I2C bus

2.1 Reader Communications (Gen2/RF Commands)

A reader communicates with Monza® X-2K Dura using standard Gen2 RFID commands. Please see the EPCglobal <u>Class-1 Generation-2 UHF RFID Air-Interface Protocol V1.2.0</u> for details.

The Gen 2 memory map is shown in Figure 2. Fields in blue text are read only. Reserved memory bank words 4-10 are read only.

MEM BANK	MEM BANK									В	ITS								
NAME	BIT ADDR	0	1	2		3	4	5	6	7	8	9	Α	В	С	D	E		F
	870 _h -87F _h		USER [15:0]																
User (11 ₂)	860 _h -86F _h		USER [31 : 16]																
=																			
l s	10 _h -1F _h									USER [2	159 : 2144]								
	00 _h -0F _h		USER [2175 : 2160]																
	B0 _h -BF _h		RFS_EPC [15:0]																
	A0 _h -AF _h										2 [31 : 16]								
	90 _h -9F _h										[47 : 32]								
	80 _h -8F _h										[63 : 48]								
-	70 _h -7F _h										[79 : 64]								
TID (10 ₂)	60 _h -6F _h										[95 : 80]								
≘	50 _h -5F _h										AL [15 : 0]								
-	40 _h -4F _h										L [31 : 16]								
	30 _h -3F _h		TID_SERIAL [47 : 32]																
	20 _h -2F _h										0] = 0x2000								
	10 _h -1F _h	TID.	TID_DESIGNER [3 : 0] = 0001 ₂ TID_MODEL [12 : 0] = 000101000000 ₂ (Gen2 model number is address 14 _h to 1F _h)																
	00 _h -0F _h				CLASS_	ID [7 :	0] = 11100	0102			XTID = 1	TID_DES	SIGNER [10	: 4] = 0000	000 ₂ (Gen2	mask designe	er is addre	ess 08 _h 1	to 13 _h)
	90 _h -9F _h									EPC [15:0]								
	80 _h -8F _h									EPC [31 : 16]								
(012)																			
EPC (30 _h -3F _h										111 : 96]								
₩	20 _h -2F _h									EPC [1	27 : 112]								
	10 _h -1F _h		EP	C_LENGTH	1[4:0]			UMI	XI = 0			NSI [8:0]	(Numbering	System Ide	ntifier, defau	lt 000000000 ₂	2)		
	00 _h -0F _h									EPC_CR	C [15 : 0]								
1	A0 _h -AF _h						RFU = 0					WWU	BPL_EN	RFS_SR	RFS_MEI	M DCI_RF_EI	N RF	_DIS [1	:0]
	90 _h -9F _h										(Read Only								
	80 _h -8F _h									RESERVE									
(00 2)	70 _h -7F _h									RESERVE									
	60 _h -6F _h									RESERVE									
l š	50 _h -5F _h										(Read Only								
Reserved	40 _h -4F _h	LOCK_KIL	LL [1 : 0]	LOCK_A	CCESS	[1:0]	LOCK_E	PC[1:0]		ISER [1:0]			PERMALO	CK [0:5]		KILL	CO	NFIG [1	:0]
2	30 _h -3F _h									CCESS_PAS									
	20 _h -2F _h								A	CCESS_PASS									
	10 _h -1F _h									KILL_PASSV									
	00 _h -0F _h									KILL_PASSW	ORD [31 : 1	6]							
	ouh-urh	l								NILL_PASSI	OKD [31:1	o j							

Figure 2– Gen2 Interface Memory Map

2.2 Support for Optional Gen 2 Commands

Following optional Gen 2 commands are supported:

Command	Code	Length	Details
Access	11000110	56	
BlockWrite	11000111	>57	 Accepts valid one-word commands Accepts valid two-word commands if pointer is an even value Returns error code (000000002) if it receives a valid two-word command with an odd value pointer Returns error code (000000002) if it receives a command for more than two words Does not respond to block write commands of zero words



Command	Code	Length	Details			
BlockPermalock	11001001	>66	• Five blocks			
			Four, 512 bits in size			
			One 128 bits in size			
			Command can be disabled through I2C			

2.3 I2C Interface (SDA, SCL, DCI Pins)

I2C is a standard two-wire interface (clock and data) that supports multiple addressable chips on a bus. Monza® X-2K Dura only supports slave capability. Monza® X-2K Dura's I2C features are compatible with the industry-standard I2C bus. Specifically Monza® X-2K Dura is compatible with I2C specification (I2C Rev 0.03, June 19 2007, NXP Doc UM10204). Monza® X-2K Dura implements the following I2C capabilities:

- I2C slave
- I2C Start Condition
- I2C Repeated Start Condition
- I2C Stop Condition
- I2C Acknowledge
- I2C 7-bit slave address (110111M)
- Fast mode transfer rates of 0-400kbits/second
- The DCI voltage provides I2C bus VOH/VOL reference and power.

When an I2C master addresses Monza® X-2K Dura it must format its write transactions as described here. In addition to the I2C device address Monza® X-2K Dura has a memory address that a master writes on every write transaction. This 9-bit memory address specifies which memory byte the master is addressing. The MSB of the memory address replaces the LSB of the I2C device address, bit M in the device ID.

The memory address stored in Monza® X-2K Dura is only changed during a write transaction (R/W == 0). During a read transaction Monza® X-2K Dura ignores the A8 bit in the first byte and there is no following byte. A master only writes a memory address, and future read transactions use the previously written address. A diagram of a transaction that writes the memory address is shown in Figure 3. All bit positions are explicitly shown so the boundary between the I2C device address and the Monza® X-2K Dura memory address is clear. Subsequent diagrams do not explicitly show these address bits.

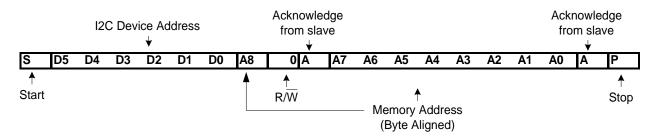


Figure 3 – Addressing the device and setting the memory address

When performing an NVM write a master transmits data after the memory address. Monza® X-2K Dura's NVM is organized as 16-bit words. Writes must align on word boundaries. The NVM allows one- or two-word writes (equivalent to two- or four-byte writes). When executing a one-word write Monza® X-2K Dura ignores the LSB (A0) of the memory address. When executing a two-word write Monza® X-2K Dura ignores the two LSBs (A1, A0) of the memory address. If the write transaction is valid then Monza® X-2K Dura begins the NVM write after receiving a stop from the I2C master. Monza® X-2K Dura will not respond to subsequent I2C transactions for the duration of the NVM write operation. The write time for one- and two-word write operations is the same. A one-word NVM write transaction is shown in Figure 4.

Monza® X-2K Dura may observe several types of invalid NVM-write transactions. If a master sends one or three data bytes then Monza® X-2K Dura will not perform the write (recall that Monza® X-2K Dura writes 16-bit words). If a master sends more than two words then Monza® X-2K Dura will not perform the write. Monza® X-2K Dura also checks the memory address and will not perform a write if the address is invalid (but note that Monza® X-2K Dura updates its memory address even if the address is invalid).

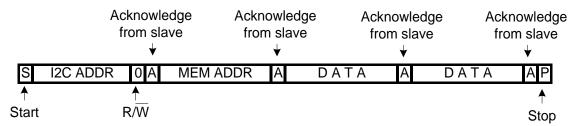


Figure 4 – One-word Monza® X-2K Dura write transaction

Figure 5 shows a read transaction. The read starts from the stored address. Monza® X-2K Dura increments the address as it sends each data byte. Monza® X-2K Dura ignores the MSB of the memory address when the R/W==1.

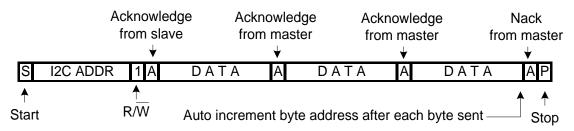


Figure 5 – Monza® X-2K Dura read transaction

Reads start from the stored address and continue to the end of memory, at which point Monza® X-2K Dura will cease exchanging data over I2C. Monza® X-2K Dura will send all ones if the master continues to read beyond the end of the memory. To read from a new location the master



must send a new address. The master may halt the read at a byte boundary and later initiate a new read transaction starting from that byte. For completeness the combined write transaction then read transaction is shown in Figure 6.

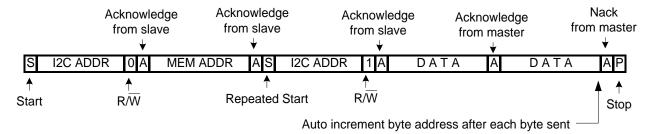


Figure 6 – Write transaction to set address followed by repeated start and read transaction.

Monza® X-2K Dura ignores all Gen2 Lock, Kill permissions when reading / writing over I2C. The I2C port has read access to the entire NVM. The I2C port has write access to most, but not all, of the NVM. Monza® X-2K Dura precludes a master from writing its manufacturing calibration fields (shown as Reserved in the I2C memory map of Figure 7); these locations are read-only.

2.4 I2C Memory Map

Gen 2 and I2C have different views on how a memory map is organized. In I2C everything is done according to bytes. One uses byte addressing, byte writing, and byte reading. In Gen2 things are done in terms of bits or 16 bit words.

Monza® X-2K Dura is a hybrid of these two approaches. It forces I2C to do one word or two word writes, but allows for byte wise reading and addressing. When reading via I2C the first bit read is always bit seven within the byte. The next byte read is at the next higher I2C byte address. The I2C memory map in byte wise format is shown in Figure 7.

An additional memory map that shows bit addressing from I2C in a word wise format is shown in Figure 8.

GEN2 BANK	I2C BYTE				BIT ADDR	ESS in BYTE				I2C
NAME	ADDR	7	6	5	4	3	2	1	0	Perm
	335	· ·	·			IAL (Byte 1)		<u> </u>		R
	334					IAL (Byte 0)				R
	333					x00				R
	332				()x20				R
	331			TIE	MODEL [7	7:0]=01000	0002			R
	330	TID	TID_DESIGNER [3 : 0] = 0001 ₂							
	329	XTID = 1	TID_DES	IGNER [10	: 4] = 00000	000 ₂ (Gen2 m	ask designe	r is address	08 _h to 13 _h)	R
TID (10 ₂)	328			C		: 0] = 111000	010 ₂			R
₽	327					_EPC				R/W
-	326					EPC				R/W
						_EPC				R/W
	316					_EPC IAL (Byte 5)				R/W
	315 314					IAL (Byte 5)				R
	313					IAL (Byte 4)				R R
	312					IAL (Byte 3)				R
	311									R/W
12)	310		USER USER							R/W
5			USER							R/W
User (11 ₂)	41					SER				R/W
	40				U	SER				R/W
	39				E	:PC				R/W
12)	38					:PC				
EPC (01 ₂)						PC				R/W
ı ğ	24					PC				R/W
	23		EDC	LENGTH [[7:0]	1.05.41	VI - 0	NOLLOI	R/W
	22 21	RFU = 0	WWU	BPL EN		OT MEM	DCI RF EN	XI = 0	NSI[8] S[1:0]	R/W R/W
	20	KFU - U	VVVVO	_		as 00000000		I KF_DI	S[1.0]	R/W
	19						2)			R/W R
						ERVED ERVED				
	10					ERVED				R R
02)	9		BLOCK	PERMALO:	CK [0:4]	LKVED	KILL	CONFI	G[1:0]	R/W
e.	8	LOCK KI] LOCK_E			SER[1:0]	R/W
Reserved (00 ₂)	7	200.1_10	[]			PASSWORD				R/W
Ser	6				ACCESS	PASSWORD)			R/W
Se Se	5		ACCESS_PASSWORD							
	4					PASSWORD				R/W
	3					ASSWORD				R/W
	2					SSWORD				R/W
	1				_	ASSWORD				R/W
	0				KILL_PA	ASSWORD				R/W

Figure 7 – I2C Interface Memory Map in a Byte Wise format



MEM BANK	I2C	BITS	NVM WORD	I2C						
NAME	BIT ADDR	0 1 2 3 4 5 6 7 8 9 A B C D E F								
IVANIL	A70 _h -A7F _h	TID SERIAL [47:32]								
	A60 _h -A6F _h									
	A50 _h -A5F _h	TID_DESIGNER [3 : 0] = 0001 ₂ TID_MODEL [11 : 0] = 000101000000 ₂ (Gen2 model number is address 14 _h to 1F _h)	ROM ROM	R R						
	A40 _h -A4F _h	CLASS ID [7:0] = 11100010 ₂ XTID = 1 TID DESIGNER [10:4] = 0000000 ₂ (Gen2 mask designer is address 08, to 13 ₄)	ROM	R						
	A30 _h -A3F _h	QT EPC[15:0]	163	R/W						
	A20 _h -A2F _h	QT EPC[31:16]	162	R/W						
_	A10 _h -A1F _h	QT EPC [47:32]	161	R/W						
(102)	A00 _h -A0F _h	QT EPC[63:48]	160	R/W						
Q1.	9F0 _h -9FF _h	QT_EPC [79:64]	159	R/W						
F	9E0 _h -9EF _h	QT_EPC [95:80]	158	R/W						
	9D0 _h -9DF _h	TID_SERIAL [15:0]	157	R						
	9C0 _h -9CF _h	TID_SERIAL [31 : 16]	156	R						
_	9B0 _h -9BF _h	USER [15 : 0]	155	R/W						
(112)	9A0 _h -9AF _h	USER [31:16]	154	R/W						
er (· · ·		R/W						
User	150 _h -15F _h	USER [2159 : 2144]	21	R/W R/W						
	140 _h -14F _h	USER [2175 : 2160]								
	130 _h -13F _h	EPC [15:0]								
	120 _h -12F _h	EPC[31:16]								
_	110 _h -11F _h	EPC [47 : 32] EPC [63 : 48]	17	R/W						
(012)	100 _h -10F _h	EPC [52:48] EPC [79:64]	16	R/W						
EPC	F0 _h -FF _h	EPC[93:04] EPC[95:80]	15 14	R/W R/W						
ᇳ	E0 _h -EF _h D0 _h -DF _h	EPC[111:96]	13	R/W						
	CO _h -CF _h	EPC [17: 49]	12	R/W						
	B0 _h -BF _h	EPC LENGTH [4 : 0] UMI	11	R/W						
	A0 _h -AF _h	RFU = 0 (Write as all zeros) WWU BPL EN QT SR QT MER DC IP F EN RF DIS [1:0]	10	R/W						
	90 _h -9F _h	RESERVED (Read Only) RESERVED (Read Only)	9	R/W R						
	90 _h -9F _h 80 _h -8F _h	RESERVED (Read Only) RESERVED (Read Only)	8	R						
~	70 _h -7F _h	RESERVED (read Only) RESERVED (Read Only)	7	R						
(00 2)	60 _h -6F _h	RESERVED (read Only) RESERVED (Read Only)	6	R						
p g	50 _h -5F _h	RESERVED (Nead Only) RESERVED (Nead Only)	5	R						
erved	40 _h -4F _h	LOCK KILL[1:0] LOCK ACCESS[1:0] LOCK EPC[1:0] LOCK USER[1:0] BLOCK PERMALOCK[0:5] CONFIG[1:0]	4	R/W						
Ses	30 _h -3F _h	ACCESS PASSWORD [15:0]	3	R/W						
-	20 _h -2F _h	ACCESS PASSWORD [31:16]	2	R/W						
	10 _h -1F _h	KILL PASSWORD [15:0]	1	R/W						
	00 _h -0F _h	KILL PASSWORD [31:16]	0	R/W						
	22,, 61, 11									
	Legends:	ROM Reserved								
	_	NVM								

Figure 8 – I2C Interface Memory Map in a Word Wise format

2.5 I2C Control of Monza® X-2K Dura Behavior

The I2C interface can control Monza® X-2K Dura behavior by writing to bytes 8 or 9, 20 or 21, and 22 or 23. The following sections describe how control bits in these words change the behavior.

2.6 Monza® X-2K Dura I2C and Gen2 Lock Bits

The lock bits for the kill password (LOCK_KILL[1:0]), the access password LOCK_ACCESS[1:0]), the EPC memory bank (LOCK_EPC[1:0]), and the USER memory bank (LOCK_ USER[1:0]) are in byte eight of memory. In each of these lock bit pairs bit one corresponds to pwd-write or pwd-read/write and bit zero corresponds to the permalock bit. Note that the I2C can always change the state of these bits and that their permissions only apply to the RF Gen2 interface.

pwd-write	permalock	Description
0	0	Associated memory bank is writeable from either the open or secured states.
0		Associated memory bank is permanently writeable from either the open or secured states and may never be locked.
1	()	Associated memory bank is writeable from the secured state but not from the open state.

Table 2.1 - Lock Bit-field functionality

1	1	Associated memory bank is not writeable from any state.
pwd- read/write	permalock	Description
0	0	Associated password location is readable and writeable from either the open or secured states.
0	1	Associated password location is permanently readable and writeable from either the open or secured states and may never be locked.
1	0	Associated password location is readable and writeable from the secured state but not from the open state.
1	1	Associated password location is not readable or writeable from any state.

2.7 Monza® X-2K Dura I2C and Gen2 BlockPermalock

Monza® X-2K Dura will segments user memory into five blocks. Blocks zero through four may be blockpermalocked from either the Gen2 interface or the I2C interface. A blockpermalocked block allows reads but not writes to the block. Blockpermalocking is permanent for blocks one through four and may not be unlocked from either interface. The blockpermalock may be undone for block zero from the I2C interface and I2C ignores the blockpermalock permission for block zero.

The five blocks as seen from the I2C interface are shown in Figure 9. The five blocks in the User memory bank as seen from the Gen2 interface are:

- Block 0: bit address 0 to bit address (512 bit block size)
- Block 1: bit address 512 to bit address 1023 (512 bit block size)
- Block 2: bit address 1024 to bit address 1535 (512 bit block size)
- Block 3: bit address 1536 to bit address 2047 (512 bit block size)
- Block 4: bit address 2048 to bit address 2175 (128 bit block size)

Please see the Gen2 specification for details on how a reader may lock the memory via *BlockPermaLock* command.

The mechanism for a microprocessor permalocking over I2C is as follows: Execute a one-word (2 byte) write to bytes eight and nine (word address four). There are five blockpermalock bits in byte nine that control the write permission to the five user-memory blocks. Monza® X-2K Dura will bitwise OR each of the current permalock bits with the four bits corresponding to blocks one through four and write the updated word into NVM. Block zero may be unlocked via the I2C interface. Monza® X-2K Dura does not allow unlocking of blockpermalocked memory in blocks one through four via either the Gen2 interface or I2C interface.

To control the Gen2 interface access to the *BlockPermalock* command the I2C interface will have a *BlockPermalock* command enable bit that only it can write to. When the bit is set Monza® X-2K Dura will execute valid *BlockPermalock* commands and when it is cleared it will ignore all *BlockPermalock* commands. The location of the BPL_EN bit is in bit five of byte 21.



GEN2 BANK NAME	I2C BYTE ADDR		BIT ADDRESS in BYTE								
		7	6	5	4	3	2	1	0	Lockable	Lockable
	311					(Block 4)				Yes	Yes
						(Block 4)				Yes	Yes
	296					(Block 4)				Yes	Yes
	295					(Block 3)				Yes	Yes
						(Block 3)				Yes	Yes
	233					(Block 3)				Yes	Yes
	232		USER (Block 3)								Yes
	231		USER (Block 2)								Yes
User (11 ₂)						(Block 2)				Yes	Yes
<u> </u>	169					(Block 2)				Yes	Yes
ls (168					(Block 2)				Yes	Yes
	167					(Block 1)				Yes	Yes
						(Block 1)				Yes	Yes
	105					(Block 1)				Yes	Yes
	104		USER (Block 1)								Yes
	103		USER (Block 0)								Yes
			USER (Block 0)								Yes
	41		USER (Block 0)								
	40				USER	(Block 0)				No	Yes

Figure 9 – BlockPermaLock blocks as seen from the I2C interface

2.8 Monza® X-2K Dura I2C Control of Config[1:0] Bits

The CONFIG[1:0] bits contain important configuration that must be preserved. Users must take care not to accidentally reprogram them when writing to bytes 8 and 9. The I2C master must read bytes 8 and 9. Then apply the values for CONFIG[1:0] to the new data that is written. The following logic operation for the word to be sent over the I2C bus will achieve this.

 $SENT_WORD = (OLD_WORD \& 0x0003) | (NEW_WORD \& 0xFFFC)$

2.9 Monza® X-2K Dura Control of the QT Function

The QT_SR and QT_MEM bits control in byte 21 control the QT functionality of Monza® X-2K Dura. They have no effect on I2C operation and only change RF Gen2 behavior. The two bits operate independently from each other. The QT_SR bit turns on Monza® X-2K Dura's short range mode when it is set. When Monza® X-2K Dura is in short range, operations in OPEN or SECURED states are required to be close to the reader. Note, however, that if the Monza® X-2K Dura antenna has a gain < -9dBi, there will be no OPEN or SECURED access through the RF port when the QT_SR bit is set. The QT_MEM bit controls how Monza® X-2K Dura's memory appears to the Gen2 interface. When the bit is set Monza® X-2K Dura is in public mode: user memory bank is hidden, TID serialization is hidden, and uses its QT_EPC in the EPC bank. When the bit is cleared Monza® X-2K Dura is in private mode and all of its memory is exposed. The memory map in Figure 2 shows the Monza® X-2K Dura memory in private mode.

The DCI_EN_RF_EN bit and the RF_DIS[1:0] bits in byte 21 are covered in the section on RF access control.

2.10 Monza® X-2K Dura I2C Control of Gen2 Response to Ack Command

The length field in byte 22 may be written from I2C. The length field specifies the number of words backscattered in response to a Gen2 Ack command. Byte 22 also contains an NVM space

for the UMI bit which may be read or written from I2C. The NVM bit is not used since it is automatically calculated per the Gen2 specification. The Gen2 UMI bit is calculated from the bitwise or of bits five through zero in byte 40.

2.11 RF Access Control

Monza® X-2K Dura provides three levels of control over RF access as follows:

- 1. Setting either or both the RF1_DIS or RF2_DIS bits in byte 21 of the NVM disables RF access on the corresponding RF port. These bits are accessible only to I2C, not RF. The factory defaults are 0, enabling RF1 and RF2.
- 2. Setting the DCI_RF_EN bit to 0 in byte 21 of the NVM inhibits all RF access when DCI voltage is present. This takes precedence over the state of the RF1_DIS, RF2_DIS bit in #1 above. This bit is also only accessible from I2C, not RF. This bit is set by factory default to 0. Thus, by default, there is RF access to RF1, RF2 when DCI voltage is NOT present and no RF access when DCI voltage is present. The specification V_{RFON} determines the DCI voltage that inhibits RF.
- 3. Setting the KILL bit 2 in byte 9 of the NVM will inhibit all RF access. This bit can be set from RF using a Gen2 KILL command or by writing from I2C. This is the normal mechanism for a reader to disable a chip. This KILL bit takes precedence over both #1 and #2 above. I2C can re-write this bit back to 0 and thus reverse and RF KILL command. The factory default for KILL is 0.

The factories defaults are set so Monza® X-2K Dura operates like any other RFID tag when DCI voltage is not present. When DCI voltage is present the default behavior, through mechanism #2 above, is to inhibit all RF access. The KILL bit is always set to 0 at the factory by Gen2 definition. In conventional RFID chips once this bit is set to 1 a chip is dead and can never be resurrected. Monza® X-2K Dura, having a hard wired I2C interface, allows un-doing the KILL operation from I2C.

2.12 Gen2/I2C Arbitration

If the DCI_RF_EN bit is set to one then Monza® X-2K Dura has three different operating states as shown in Figure 10. The states are "Internal Control", "I2C Control", and "Idle or RF Receive". If the DCI_RF_EN bit is set to zero then Monza® X-2K Dura will not respond to RF commands when in the Idle or RF Receive state.

Internal Control: Monza® X-2K Dura is in *Internal Control* when (1) executing an initialization sequence, (2) writing the NVM or (3) backscattering a response to an RF command. When in *Internal Control* Monza® X-2K Dura ignores I2C transactions or RF commands.

I2C Control: Monza® X-2K Dura is in *I2C Control* when a master is issuing commands to Monza® X-2K Dura over the I2C bus. I2C Control starts when Monza® X-2K Dura detects a matching device ID and is not under *Internal Control*. The I2C bus master releases control of Monza® X-2K Dura either by ending a transaction with a stop bit or by issuing a subsequent start with a non-matching device ID. If Monza® X-2K Dura was commanded to perform an NVM write then it moves to *Internal Control*, otherwise it returns to idle. When in *I2C Control* Monza® X-2K Dura ignores all RF commands. Note that the master may stall the I2C bus (by holding SCL low) in the middle of a transaction and prevent RF access until releasing the bus.

Idle or RF Receive: Monza® X-2K Dura is in *Idle or RF Receive* when receiving an RF command or when idle. After receiving a command Monza® X-2K Dura transitions to *Internal*



Control to execute the command. Executing a command may cause Monza® X-2K Dura to (1) backscatter a reply (2) write to NVM or (3) change internal states. An I2C transaction may interrupt Monza® X-2K Dura in *Idle or RF Receive*— by this means the I2C port exercises priority over the RF port and may not be locked out. Note that I2C is locked out when Monza® X-2K Dura transitions to *Internal Control* to execute the command.

In certain operating states and under certain conditions Monza® X-2K Dura may appear unresponsive to an I2C master for up to 20 milliseconds (During a slow Gen2 backscatter). This datasheet recommends that an I2C master have a retry algorithm that can accommodate Monza® X-2K Dura being busy.

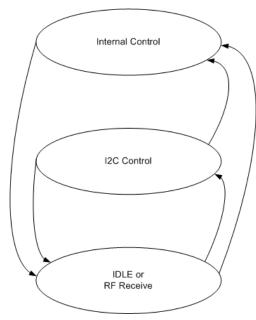


Figure 10 – Monza® X-2K Dura operating states

2.13 Write Wakeup Mode

Monza® X-2K Dura has a wake up feature that is tied to writes being performed over the Gen2 interface. In order to enable this feature the I2C master must set the WWU bit (bit 6 of byte 21) to one. Then the master must set the Monza® X-2K Dura's DCI pin to 0V (Sleep mode). The SCL and SDA lines must remain high, but draw no current. A reader may continue to interact with Monza® X-2K Dura on the RF ports. If a reader performs a write operation, and the wake up mode is set, Monza® X-2K Dura will assert the SCL IO pulling the SCL line low for the duration of the write operation, approximately 4ms. This transition may then be detected by the sleeping master and used to wake up the system.

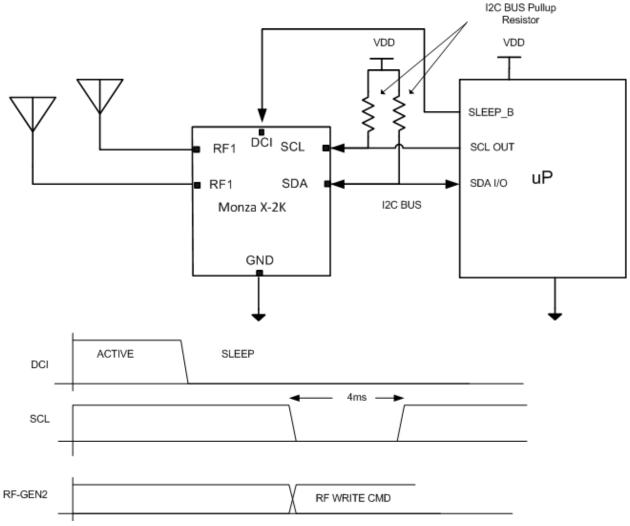


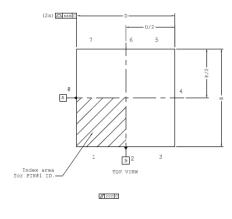
Figure 11 – Monza® X-2K Dura write wake up mode schematic and timing diagram

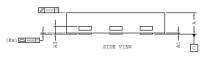


Chip Characteristics

3.1 **Physical Characteristics**

Parameter Description		Condition	Min	Nom	Max	Units	Comments
IC package Chip package		All	XQFN 8L 1.65×1.65×0.35mm				
Pin count	Package pins	All		8		pins	2 – Port1 RF+/– 2 – Port2 RF+/– 2 – DCI/gnd 2 – I2C(SDA/SCL)





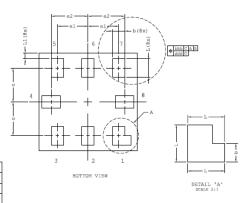
Tolerances:

aaa = 0.1 (Coplanarity top surface)
bbb = 0.1 (Position lead)

ccc = 0.05 (Parallelism top & bottom)

ddd = 0.05 (Position lead)

eee = 0.05 (Coplanarity bottom surface)



- Notes:
 1. All dimensions are in millimeter.
 2. Max. package warpage is 0.05mm.
 3. Maximum allowabe burrs is 0.076mm in all directions.
 4. Pin *I ID on top will be laser/ink marked.
 5. Dimension applies to metalized terminal and is measured
- between 0.20 and 0.25mm from terminal tip. 6. Applied only for terminals.
- Applied for exposed pad and terminals.
 Refer JEDEC MO-255.
- 9. Exposed pad finish NiPdAu.

Figure 12-Packing Dimensions

1.60 0.50 BSG

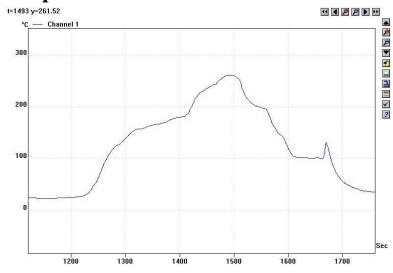
0.25 0.30 0.35

3.2 Absolute Maximum Ratings

Parameter	Description	Condition	Min	Nom	Max	Units	Comments
Absolute maximum pin voltage	Absolute maximum voltage on any chip pin	All except DCI	-0.3		4.1	V	From the I2C spec, the max DC voltage is 3.3V+20% (max operating voltage) + 0.5V for survivability
ESD		HBM	2			kV	
ESD		CDM	500			V	
Operating Temperature	Temperature for full specified performance		-25		+85	°C	See Read/Write Sensitivity for temperature ranges in Section 3.4
Persistence Temperature	Temperature for Gen2 flag persistence		-25		+40	°C	As per the Gen2 v.1.2.0 specification for flag persistence
Storage temperature	Temperature for 10-yr NVM retention		-40		+85	°C	See Impinj's NVM usage model
Assembly survival temp	Temperature for reflow soldering / assembly				+260	°C	Peak temp of JEDEC-MO255 for lead free soldering
Moisture Sensitivity Level	Moisture/Reflow Sensitivity Classification			MSL 1			According to IPC/JEDEC's J-STD-20



3.3 Reflow Temperature Profile



3.4 Electrical Characteristics

Parameter	Description	Condition	Min	Nom	Max	Units	Comments
		RF Perfo	ormano	ee			
	S _{READ} Matched RF Input Read Sensitivity DRM, M=4	No DC Input		-17		dBm	
$\mathbf{S}_{ extbf{READ}}$		With DC Input at 0°C to +85°C		-24		dBm	Using DC
		With DC Input at 0°C to -25°C		-20		dBm	Input, Monza X-2K Dura can be used in Battery
		No DC Input		-12		dBm	Assisted Passive mode to increase
S_{WRITE}	Matched RF Input Write Sensitivity DRM, M=4	With DC Input at 0°C to +85°C		-24		dBm	read/write range
		With DC Input at 0°C to -25°C		-20		dBm	
Rp	Parallel Equivalent Real Input Impedance	At Sensitivity		1600		Ohms	

Parameter	Description	Condition	Min	Nom	Max	Units	Comments
Ср	Parallel Equivalent RF Input Capacitance			1		pF	

Part Order#: IPJ-P6001-Q2AT



Parameter	Description	Condition	Min	Nom	Max	Units	Comments
		POV	VER				
V_{DCI}	DCI Input Voltage/I2C Reference		1.6		3.6	V	These DCI voltages are with a ±100mV tolerance
I_{DCW}	Current drawn by chip	1.6 <v<sub>DCI<2.0</v<sub>		100	200	μΑ	Nominal 80uA at 1.6V
	during write	2.0 <v<sub>DCI<3.6</v<sub>		140	220		1.0 V
I_{DCI}	Current drawn by chip	1.6 <v<sub>DCI<2.0</v<sub>		15	30	μΑ	
	during read or idle	2.0 <v<sub>DCI<3.6</v<sub>		20	40		
${ m T_{PU}}$	Power Up Time. Time from V _{DCI} applied until I2C accepts transactions.	V _{DCI} =1.6V			2	ms	NOTE: I2C will not interrupt a write operation. This could delay I2C access up to 20ms if RF is writing.
$ m V_{RF_EN}$	Max Vdd for which RF will always be enabled				0.25	V	Applies if the DCI_RF_EN bit
V _{RF_DIS}	Min Vdd for which RF will always be disabled						is set to 0.

Parameter	Description	Condition	Min	Nom	Max	Units	Comments		
	I2C								
V _{IH}	HIGH-level input voltage	All	70%			%V _{DCI}			
V_{IL}	LOW-level input voltage	All			30%	%V _{DCI}	From the section 6 of the I2Cspecification		
V _{HYS}	Input hysteresis	All	0.1			V	1		

Parameter	Description	Condition	Min	Nom	Max	Units	Comments
I_{OL}	LOW-level output current	V _{OL} =0.4	3**			mA	
T_{OF}	Output Fall Time	Bus C= 40-400pf	20		250	ns	
C _I	Pin Capacitance				10	pF	Total capacitive load on the SDA/SCL pins
I_{IL}	SCL/SDA Input Leakage Current	Vin=3.7V 0V <v<sub>DCI<3.7V</v<sub>		1	100	nA	Exceeds I2C spec of 10uA

^{**} I_{OL} is tested with worst case minimum pull-up resistance value of 536 ohms at 2v. Applications should use as high pull-up resistance as possible consistent with the bus capacitance for the application. See the I2C specification for choosing pull-up resistor values. Values of 5K or more are typical in low power applications

3.5 Memory Characteristics

Parameter	Description	Condition	Min	Nom	Max	Units	Comments
EPC memory	EPC NVM	In private mode only		128		bits	User writeable. This memory is hidden over RF when QT is enabled.
User memory	Total user NVM	In private mode only		2176		bits	User defined memory space. This memory is hidden over RF when QT is enabled
QT alternative EPC	Alternative EPC presented during RF singulation	In public mode only		96		bits	A user can switch the tag's RF QUERY-ACK response from EPC to alternative EPC using the QT command
Kill/Access Passwords	Password NVM	Access required		64		bits	Standard 32-bit Gen2 access and kill passwords
TID mfg#/serial#	TID ROM	In private mode only		96		bits	TID serial number is hidden over RF when QT is enabled
Total Memory	Total memory size			2560		bits	
T_{WRITE}	Memory write time 16 or 32 bits			4.7	5	ms	



3.6 RF Functionality

Parameter	Description	Condition	Min	Nom	Max	Units	Comments
Air protocol	Gen2 V1.2.0	All					No recommissioning; no blockerase
RF ports	Number of RF ports	All		2			Dual-differential RF ports
RF Port Disable	NVM Settable bit per port						The operation of one or both RF ports may be disabled by setting NVM bits through the I2Cport
DC Blocks RF	NVM Settable bit						Option to allow the presence of DC to disable both RF ports

3.7 I2C Characteristics

Parameter	Description	Condition	Min	Nom	Max	Units	Comments
I2C port	Number of ports	All			1		Slave I2C (SCL/SDA)
I2C functionality	Compatible with I2C-bus specification and user manual Rev. 03 – 19 June 2007	All		R/W			An external device can R/W memory
Supported I2C features	Features: Start condition Stop condition Acknowledge 7-bit slave address					Sla	we Configuration mandatory mandatory mandatory mandatory
I2Cwrite size	Word size for I2C write	All	16		32	bits	Writes are on word addresses and not byte addresses
I2C read size	Word size for I2C read	All		N×8		bits	May read data 8bits at a time, where N is limited by start address and bank size
I2C memory arbitration	RF/I2C port priority	All		1 st			RF/I2C arbitrate for NVM access
I2C Address	I2C Device Address	All		110111M ¹			

Parameter	Description	Condition	Min	Nom	Max	Units	Comments
Transfer rates	I2C transfer data rates	All	0		400	kbps	I2C fast mode

¹Monza(R) X-2K Dura operates like most I2C EEPROM devices in that the LSB of the 7-bit I2C device address is the MSB of the NVM address. The 8 LSBs of the NVM address are sent in the next I2C byte.

3.8 NVM Usage Model

	Condition					
Writes per row	Total writes	Power-on time	Retention (years)			
10	100	5 yr	50			
1k	10k	1 yr	10			
10k	100k	2k hours	1			

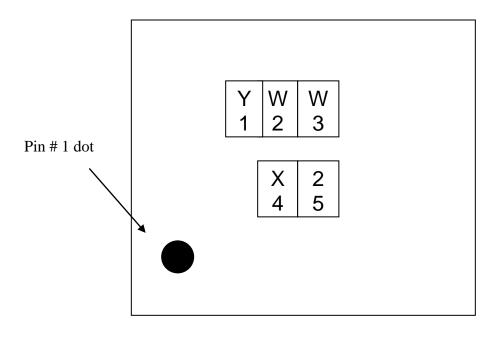
3.9 Environmental Compliance

Requirement	Comments
RoHS	Monza X-2K Dura is RoHS compliant. It meets the directive 2002/95/EC (RoHS). RoHS declaration letter is available upon request.
REACH	Monza X-2K Dura does not, to our current knowledge, contain substances above the legal threshold that are on the Candidate List of Substances of Very High Concern (SVHC). Our company's intention is that all products sold to our EU and EEA customers by our legal entities in Europe are compliant with REACH regulatory requirements. REACH declaration letter is available upon request.



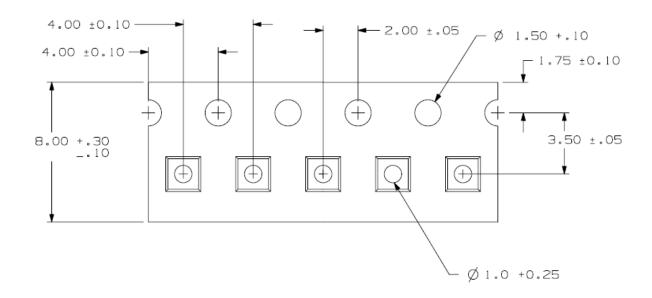
4 Product Delivery Specifications

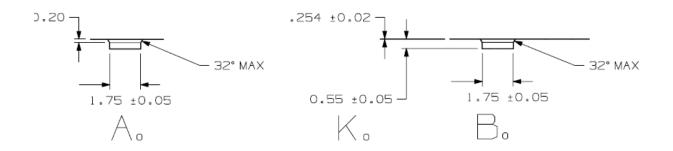
4.1 Marking Specification



Y= Year of production (1 = 2011, 2 = 2012 ...) WW = Work Week of production X2 = Product Code (Monza X-2K Dura)

4.2 Tape and Reel Specification





Parts per reel / Minimum order quantity: 3000



5 Errata

The following table lists the known issues in Monza® X-2K Dura

Issue Number	Description			
1	When writing from the I2C block the cache for the PC length field is not properly updated after I2C writes. The part must be power cycled to have the cache updated.			
2	If QT features are changed from I2C, then the changes don't take effect until power is cycled. Specifically, Monza® X-2K Dura does not recache the RFS_MEM (1=Monza® X-2K Dura is using the alternate EPC) or RFS_SR (1= tag is in short range) when written from I2C. It needs to be power cycled for the change to take effect.			

6 Footprint Compatibility with Impinj® Monza® X-2K Dura

Monza® X-8K Dura (Part Order#: IPJ-P6005-X2AT) is a higher memory capacity version of Monza® X-2K Dura.

Monza® X-8K Dura is designed to have 8192 bits of user NVM, enabling more OTP blocks. Its package dimensions are 2.0x2.0x0.35 mm. It is designed to be a drop-in replacement for Monza X-2K Dura if the layout footprint recommended below is used. For more details about the Monza® X-8K Dura including product availability, please contact Impinj.

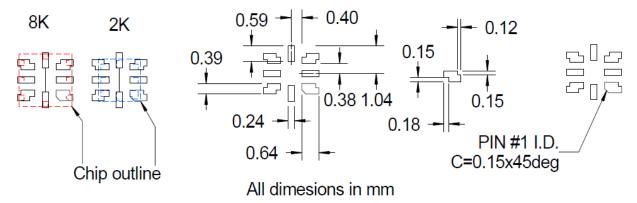


Figure 13 – Recommended common layout footprint for Monza® X-2K Dura and Monza® X-8K Dura



7 Ordering Information

Model	Part Number	User Memory	Package Size
Monza X-2K Dura	IPJ-P6001-Q2AT	2,176 bits	1.6 x 1.6 x 0.35 mm
Monza X-8K Dura	IPJ-P6005-X2AT	8,192 bits	2.0 x 2.0 x 0.35 mm

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